

# 2SC1740M

## / Descriptions

SOT-23          NPN

## / Features

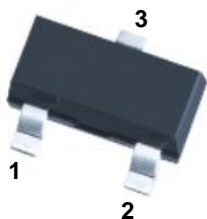
, 2SA933M

## / Applications

## / Equivalent Circuit



## / Pinning

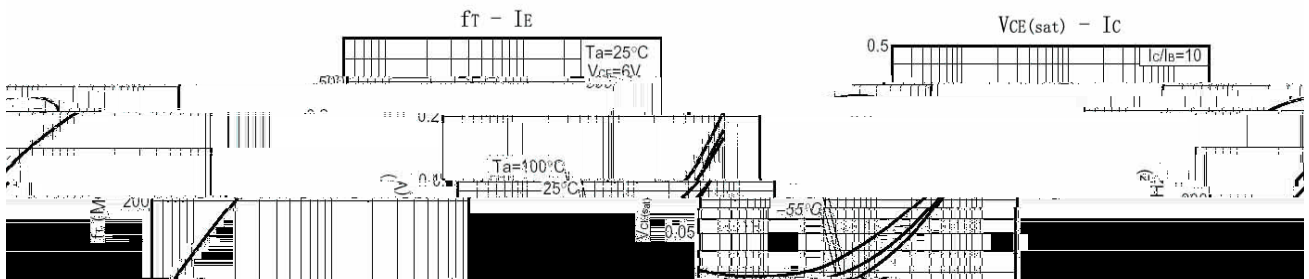
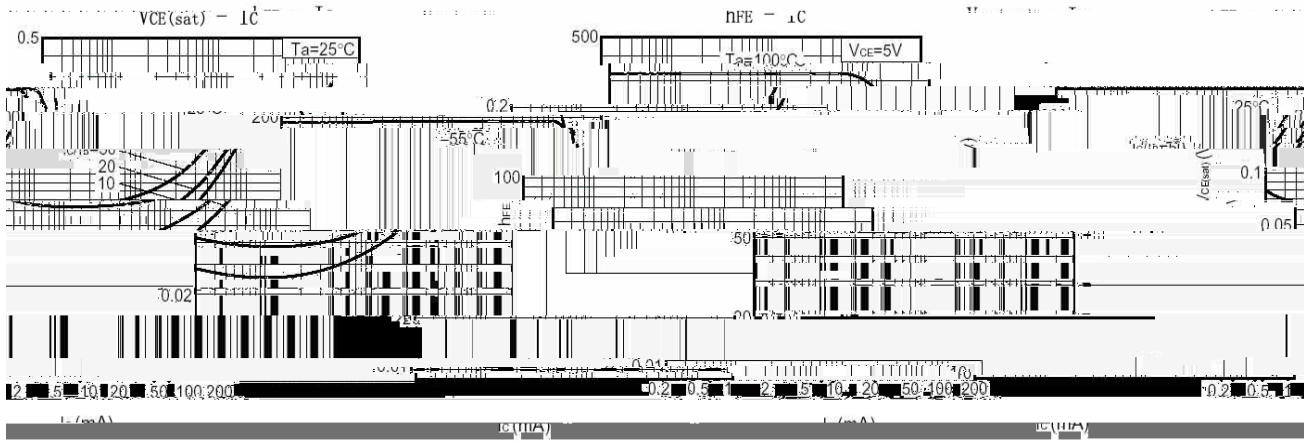


## / $h_{FE}$ Classifications & Marking

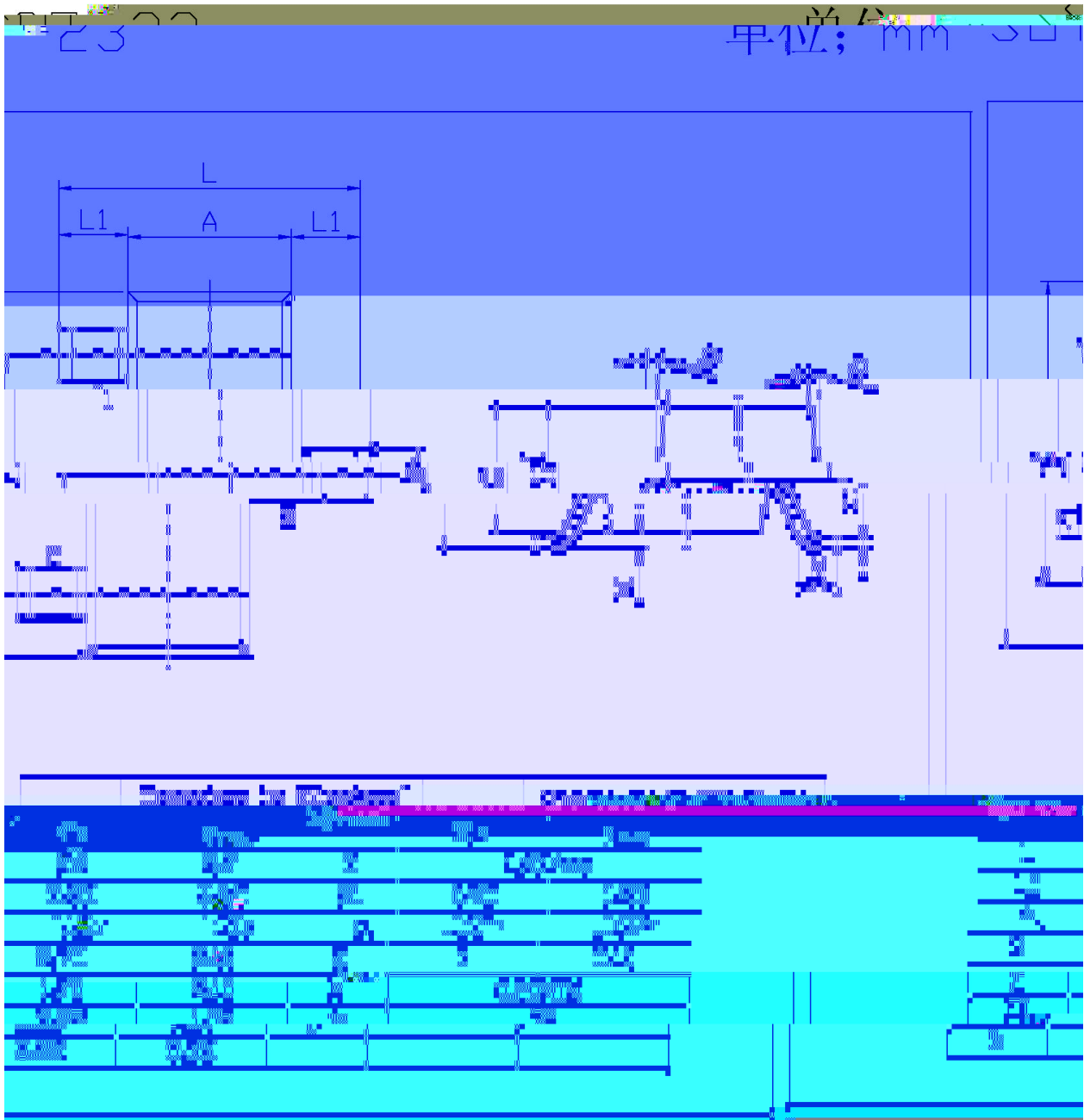


		μ				
		μ				

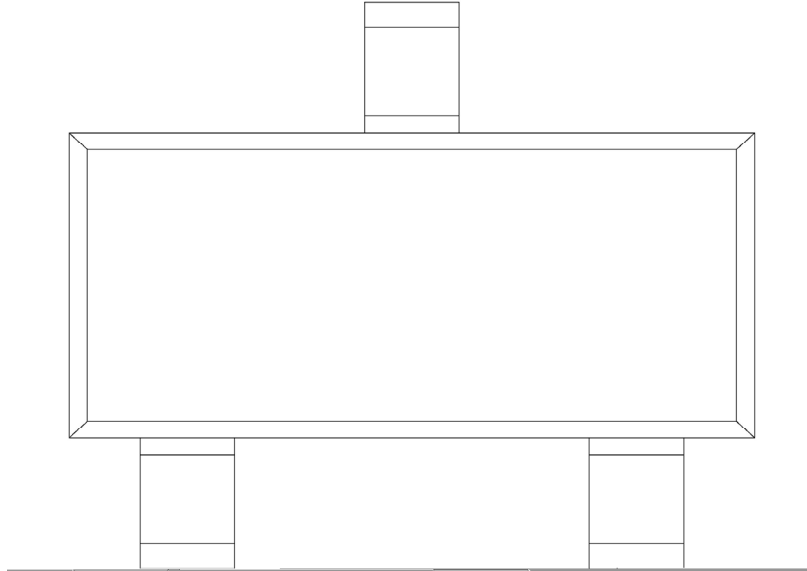
/ Electrical Characteristic Curve



/ Package Dimensions



/ Marking Instructions



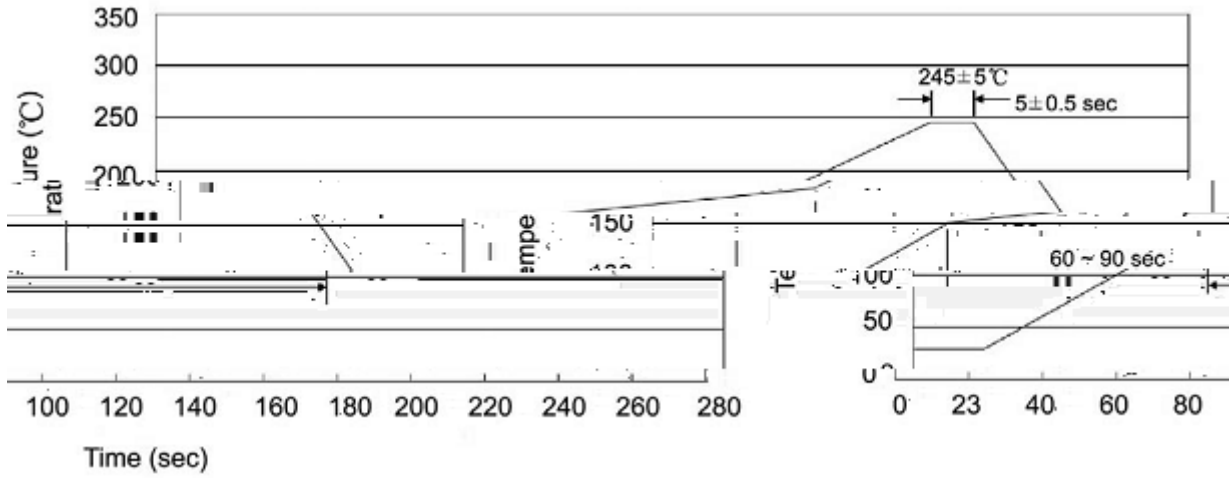
B

Q:

$h_{FE}$

h

( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-23	3,000	10	30,000	6	180,000	7 ×8	180×120×180	390×385×205

/ Notices